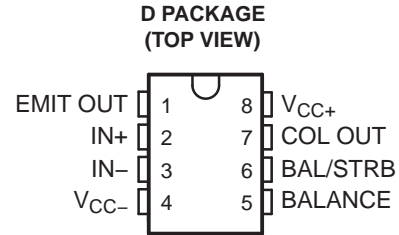


## FEATURES

- **Controlled Baseline**
  - One Assembly/Test Site, One Fabrication Site
- **Extended Temperature Performance of –55°C to 125°C**
- **Enhanced Diminishing Manufacturing Sources (DMS) Support**
- **Enhanced Product Change Notification**
- **Qualification Pedigree <sup>(1)</sup>**
- **Fast Response Times**
- **Strobe Capability**
- **Maximum Input Bias Current . . . 300 nA**
- **Maximum Input Offset Current . . . 70 nA**
- **Can Operate From Single 5-V Supply**

(1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold-compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.



## DESCRIPTION/ORDERING INFORMATION

The LM211-EP is a single high-speed voltage comparator. This device is designed to operate from a wide range of power-supply voltages, including  $\pm 15$ -V supplies for operational amplifiers and 5-V supplies for logic systems. The output levels are compatible with most TTL and MOS circuits. This comparator is capable of driving lamps or relays and switching voltages up to 50 V at 50 mA. All inputs and outputs can be isolated from system ground. The outputs can drive loads referenced to ground,  $V_{CC+}$  or  $V_{CC-}$ . Offset balancing and strobe capabilities are available, and the outputs can be wired-OR connected. If the strobe is low, the output is in the off state, regardless of the differential input.

### ORDERING INFORMATION

| $T_A$          | $V_{IO\ max}$<br>AT 25°C | PACKAGE <sup>(1)</sup> |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|--------------------------|------------------------|---------------|-----------------------|------------------|
| –40°C to 125°C | 3 mV                     | SOIC – D               | Tape and reel | LM211QDREP            | LM211E           |
| –55°C to 125°C | 3 mV                     | SOIC – D               | Tape and reel | LM211MDREP            | LM211M           |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

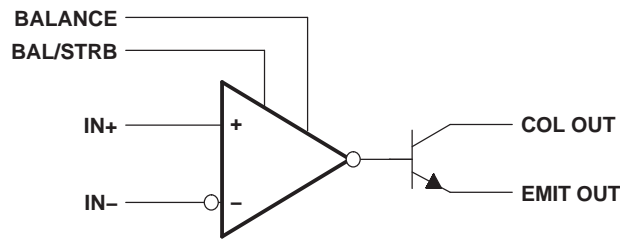


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

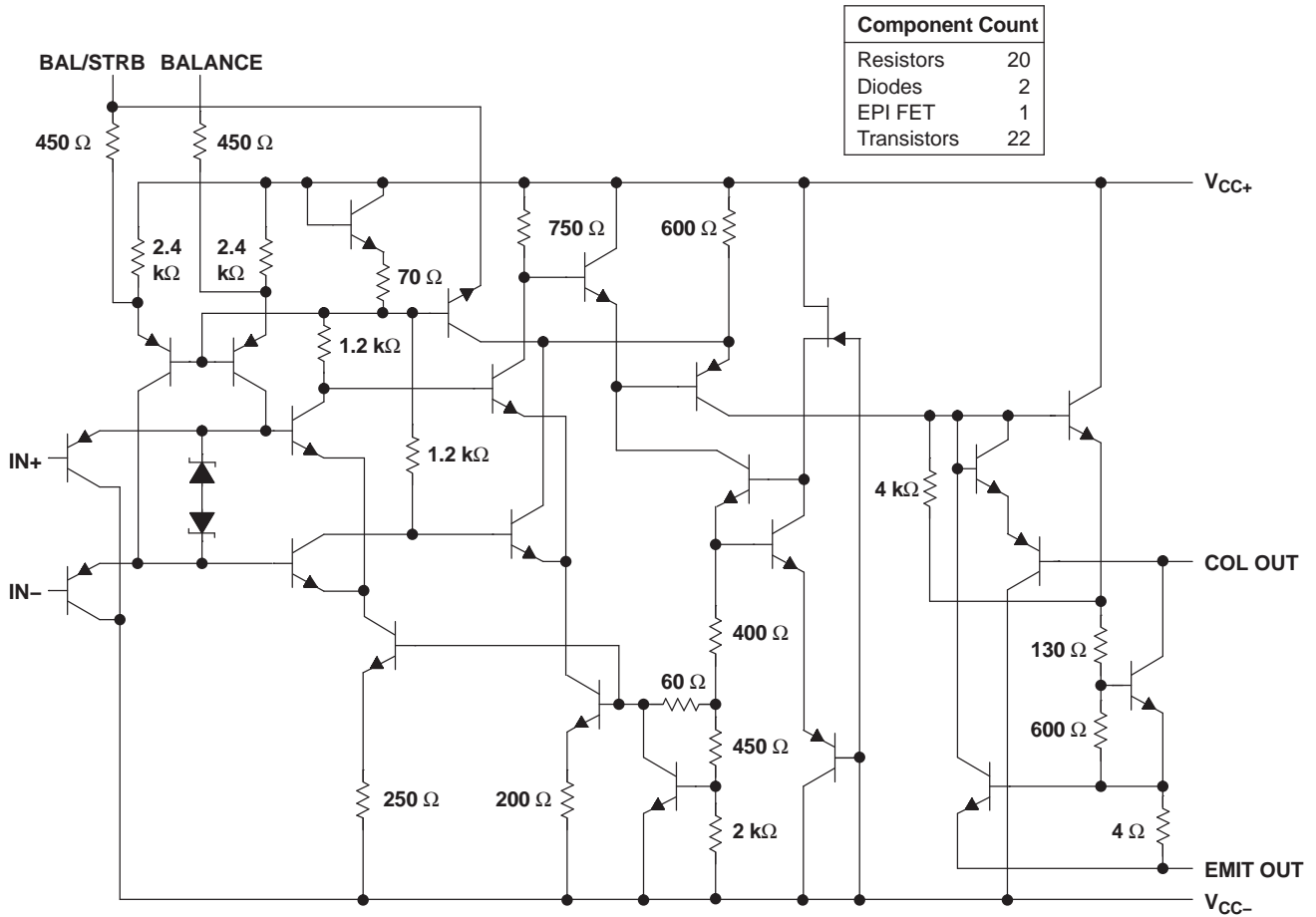
# LM211-EP DIFFERENTIAL COMPARATOR WITH STROBES

SLCS140A-DECEMBER 2002-REVISED MAY 2006

## FUNCTIONAL BLOCK DIAGRAM



## SCHEMATIC



All resistor values shown are nominal.

### Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                     |  | MIN | MAX | UNIT |
|---------------------|--|-----|-----|------|
| $V_{CC+}$           | Supply voltage <sup>(2)</sup>                        |     | 18  | V    |
| $V_{CC-}$           |  |     | -18 |      |
| $V_{CC+} - V_{CC-}$ |  |     | 36  |      |
| $V_{ID}$            | Differential input voltage <sup>(3)</sup>            |     | ±30 | V    |
| $V_I$               | Input voltage, either input <sup>(2)(4)</sup>        |     | ±15 | V    |
|                     | Voltage from emitter output to $V_{CC-}$             |     | 30  | V    |
|                     | Voltage from collector output to $V_{CC-}$           |     | 50  | V    |
|                     | Duration of output short circuit <sup>(5)</sup>      |     | 10  | s    |
| $T_J$               | Junction temperature                                 |     | 148 | °C   |
| $\theta_{JA}$       | Package thermal impedance <sup>(6)</sup>             |     | 97  | °C/W |
|                     | Lead temperature 1,6 mm (1/16 in) from case for 10 s |     | 260 | °C   |
| $T_{stg}$           | Storage temperature range <sup>(7)</sup>             | -65 | 150 | °C   |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values, unless otherwise noted, are with respect to the midpoint between  $V_{CC+}$  and  $V_{CC-}$ .
- (3) Differential voltages are at IN+ with respect to IN-.
- (4) The magnitude of the input voltage must never exceed the magnitude of the supply voltage or ±15 V, whichever is less.
- (5) The output may be shorted to ground or either power supply.
- (6) The package thermal impedance is calculated in accordance with JESD 51-7.
- (7) Long-term high-temperature storage and/or extended use at maximum recommended operating conditions may result in a reduction of overall device life. See [http://www.ti.com/ep\\_quality](http://www.ti.com/ep_quality) for additional information on enhanced plastic packaging.

### Recommended Operating Conditions

|                     |   | MIN             | MAX             | UNIT |
|---------------------|---|-----------------|-----------------|------|
| $V_{CC+} - V_{CC-}$ | Supply voltage                                  | 3.5             | 30              | V    |
| $V_I$               | Input voltage ( $ V_{CC+}  \leq 15$ V)          | $V_{CC-} + 0.5$ | $V_{CC+} - 1.5$ | V    |
| $T_A$               | Operating free-air temperature range for Q temp | -40             | 125             | °C   |
| $T_A$               | Operating free-air temperature range for M temp | -55             | 125             | °C   |

# LM211-EP DIFFERENTIAL COMPARATOR WITH STROBES

SLCS140A–DECEMBER 2002–REVISED MAY 2006

## Electrical Characteristics

at specified free-air temperatures of Q and M temp ranges,  $V_{CC+} = \pm 15\text{ V}$  (unless otherwise noted)

| PARAMETER   |   | TEST CONDITIONS  | $T_A$ (1)  | MIN         | TYP (2)       | MAX           | UNIT |
|-------------|---|--|------------|-------------|---------------|---------------|------|
| $V_{IO}$    | Input offset voltage (3)                        |  | 25°C       | 0.7         | 3             | mV            |      |
|             |   |  | Full range |             | 4             |               |      |
| $I_{IO}$    | Input offset current (3)                        |  | 25°C       | 4           | 10            | nA            |      |
|             |   |  | Full range |             | 20            |               |      |
| $I_{IB}$    | Input bias current                              | $V_O = 1\text{ V to }14\text{ V}$  | 25°C       | 75          | 100           | nA            |      |
|             |   |  | Full range |             | 150           |               |      |
| $I_{IL(S)}$ | Low-level strobe current (4)                    | $V_{(\text{strobe})} = 0.3\text{ V}, V_{ID} \leq -10\text{ mV}$  | 25°C       | -3          |               | mA            |      |
| $V_{ICR}$   | Common-mode input voltage range                 |  | Full range | 13 to -14.5 | 13.8 to -14.7 | V             |      |
| $A_{VD}$    | Large-signal differential voltage amplification | $V_O = 5\text{ V to }35\text{ V}, R_L = 1\text{ k}\Omega$  | 25°C       | 40          | 200           | V/mV          |      |
| $I_{OH}$    | High-level (collector) output leakage current   | $I_{(\text{strobe})} = -3\text{ mA}, V_{OH} = 35\text{ V}, V_{ID} = 5\text{ mV}$   | 25°C       | 0.2         | 10            | nA            |      |
|             |   |  | Full range |             | 0.5           | $\mu\text{A}$ |      |
| $V_{OL}$    | Low-level (collector-to-emitter) output voltage | $I_{OL} = 50\text{ mA}, V_{ID} = -5\text{ mV}, V_{CC+} = 4.5\text{ V}, V_{CC-} = 0, I_{OL} = 8\text{ mA}, V_{ID} = -6\text{ mV}$ | 25°C       | 0.75        | 1.5           | V             |      |
|             |   |  | Full range |             | 0.23          |               | 0.4  |
| $I_{CC+}$   | Supply current from $V_{CC+}$ , output low      | $V_{ID} = -10\text{ mV}, \text{No load}$   | 25°C       | 5.1         | 6             | mA            |      |
| $I_{CC-}$   | Supply current from $V_{CC-}$ , output high     | $V_{ID} = 10\text{ mV}, \text{No load}$  | 25°C       | -4.1        | -5            | mA            |      |

- (1) Unless otherwise noted, all characteristics are measured with BALANCE and BAL/STRB open and EMIT OUT grounded. Full range is  $-40^\circ\text{C}$  to  $125^\circ\text{C}$  for Q temp and  $-55^\circ\text{C}$  to  $125^\circ\text{C}$  for M temp.
- (2) All typical values are at  $T_A = 25^\circ\text{C}$ .
- (3) The offset voltages and offset currents given are the maximum values required to drive the collector output up to 14 V or down to 1 V with a pullup resistor of  $7.5\text{ k}\Omega$  to  $V_{CC+}$ . These parameters actually define an error band and take into account the worst-case effects of voltage gain and input impedance.
- (4) The strobe should not be shorted to ground; it should be current driven at  $-3\text{ mA}$  to  $-5\text{ mA}$  (see [Figure 13](#) and [Figure 27](#)).

## Switching Characteristics

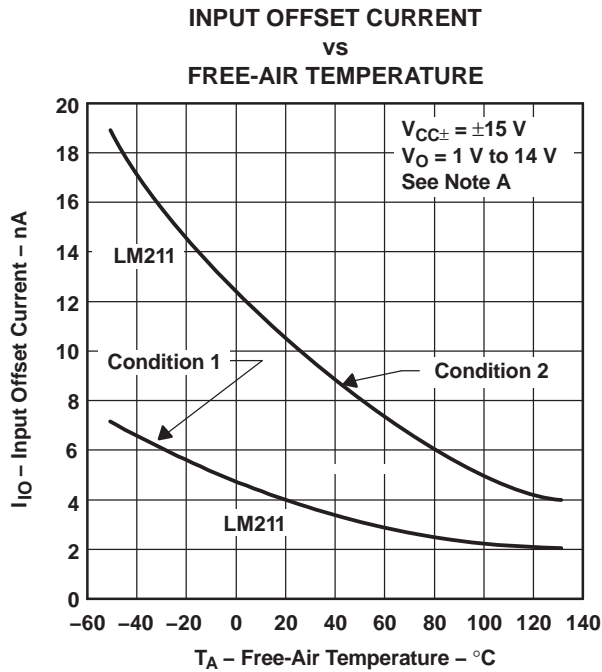
$V_{CC+} = \pm 15\text{ V}, T_A = 25^\circ\text{C}$

| PARAMETER                               | TEST CONDITIONS                      |                           | TYP | UNIT |
|---|--------------------------------------|---------------------------|-----|------|
| Response time, low-to-high-level output | $R_C = 500\ \Omega$ to $5\text{ V},$ | $C_L = 5\text{ pF}^{(1)}$ | 115 | ns   |
| Response time, high-to-low-level output | $R_C = 500\ \Omega$ to $5\text{ V},$ | $C_L = 5\text{ pF}^{(1)}$ | 165 | ns   |

- (1) The response time specified is for a 100-mV input step with 5-mV overdrive and is the interval between the input step function and the instant when the output crosses 1.4 V.

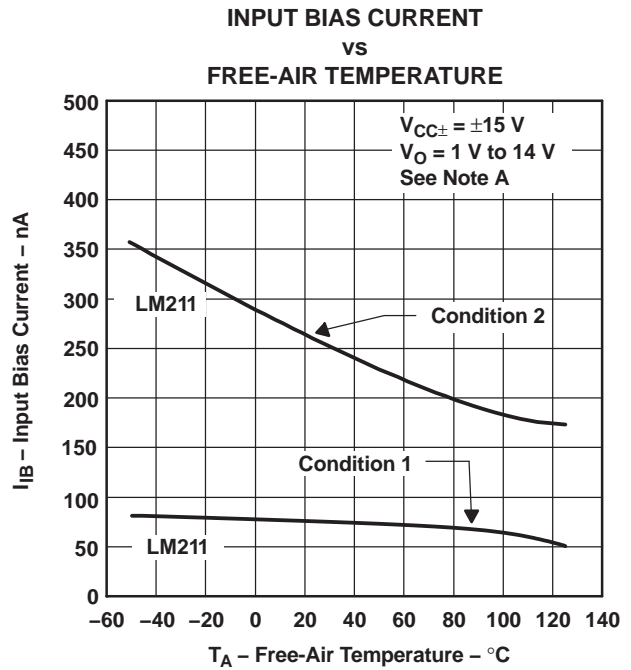
**TYPICAL CHARACTERISTICS**

Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



NOTE A: Condition 1 is with BALANCE and BAL/STRB open. Condition 2 is with BALANCE and BAL/STRB connected to V<sub>CC+</sub>.

**Figure 1.**

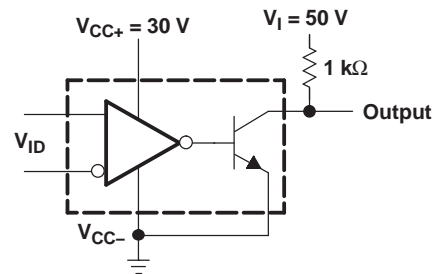
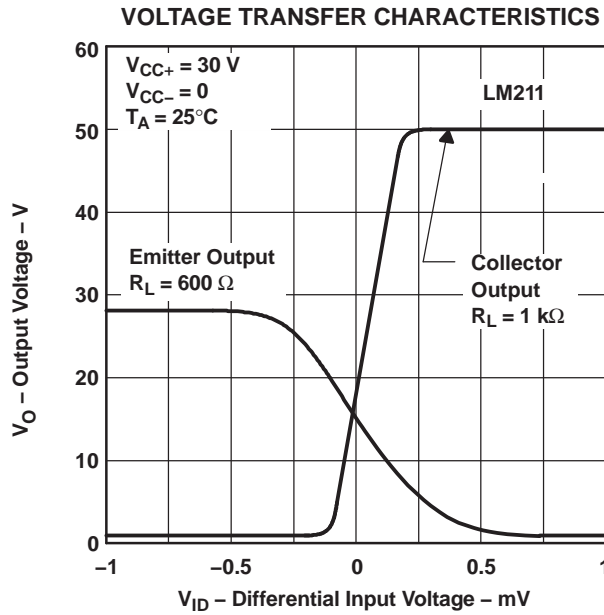


NOTE A: Condition 1 is with BALANCE and BAL/STRB open. Condition 2 is with BALANCE and BAL/STRB connected to V<sub>CC+</sub>.

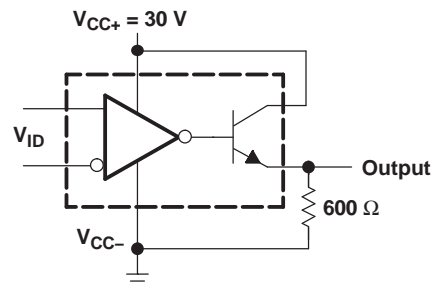
**Figure 2.**

**TYPICAL CHARACTERISTICS (continued)**

Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



**COLLECTOR OUTPUT TRANSFER CHARACTERISTIC TEST CIRCUIT FOR FIGURE 3**



**EMITTER OUTPUT TRANSFER CHARACTERISTIC TEST CIRCUIT FOR FIGURE 3**

**Figure 3.**

**TYPICAL CHARACTERISTICS (continued)**

Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

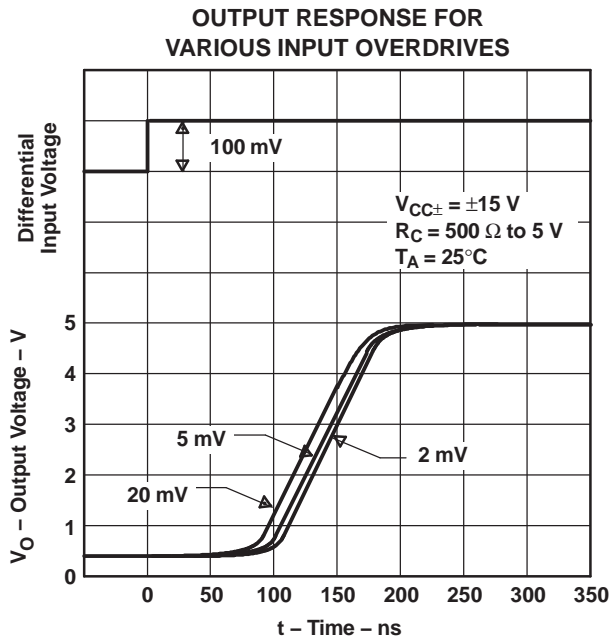


Figure 4.

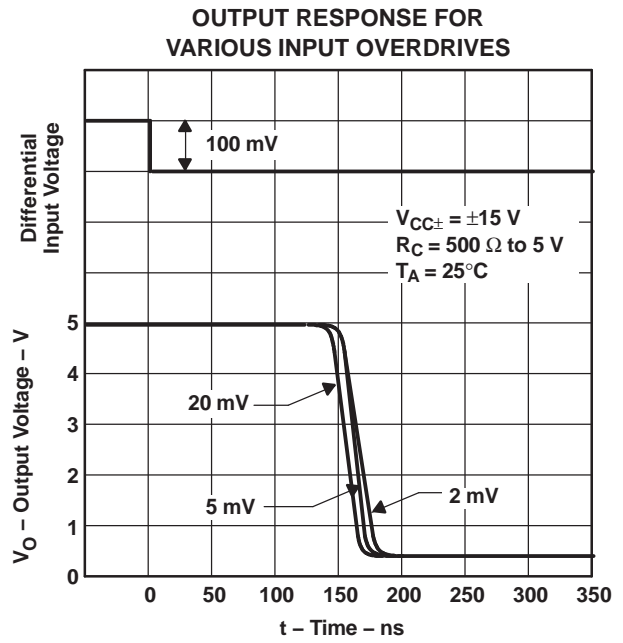
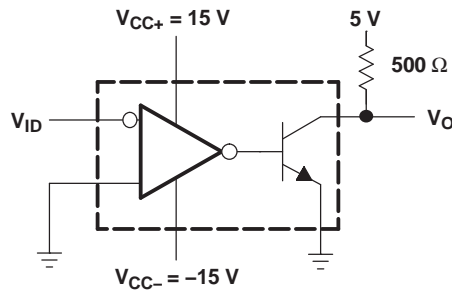


Figure 5.



TEST CIRCUIT FOR FIGURES 4 AND 5

TYPICAL CHARACTERISTICS (continued)

Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

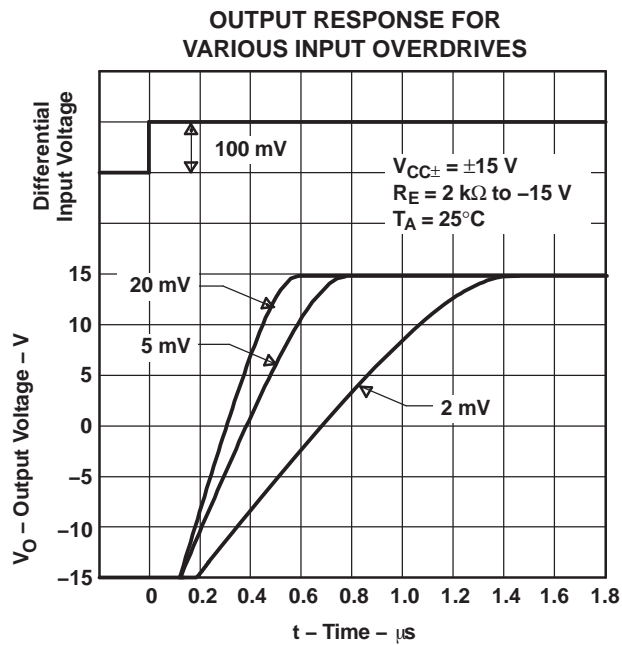


Figure 6.

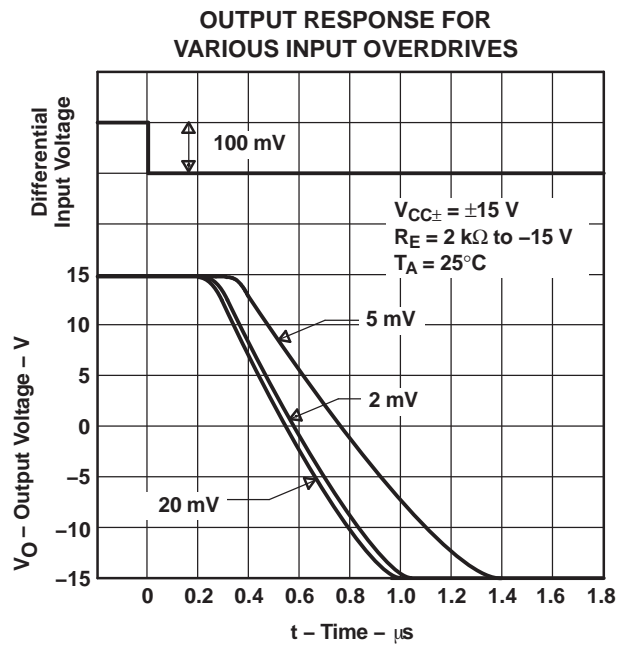
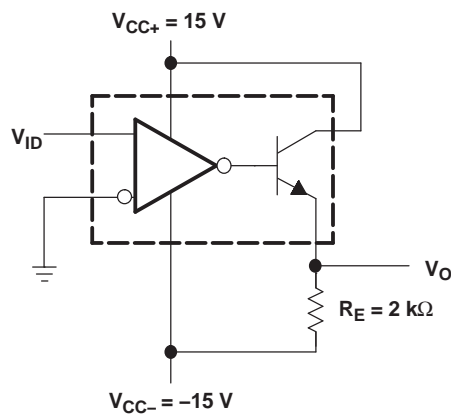


Figure 7.



TEST CIRCUIT FOR FIGURES 6 AND 7



**TYPICAL CHARACTERISTICS (continued)**

Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

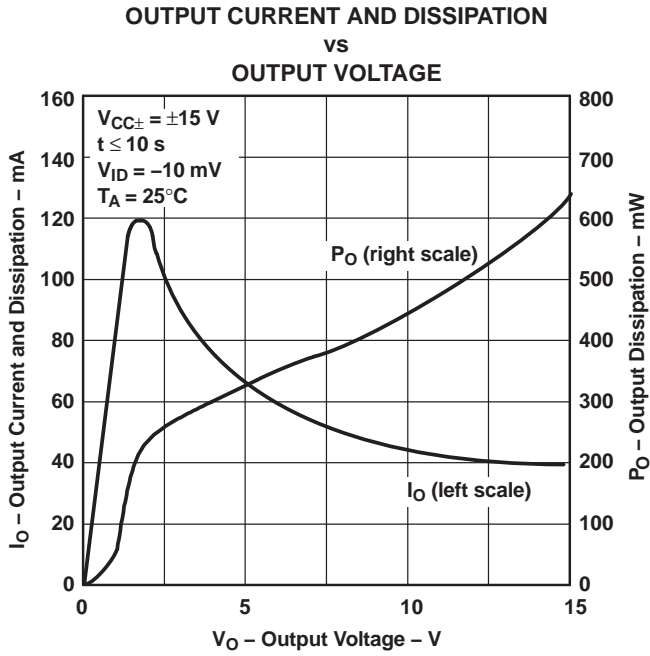


Figure 8.

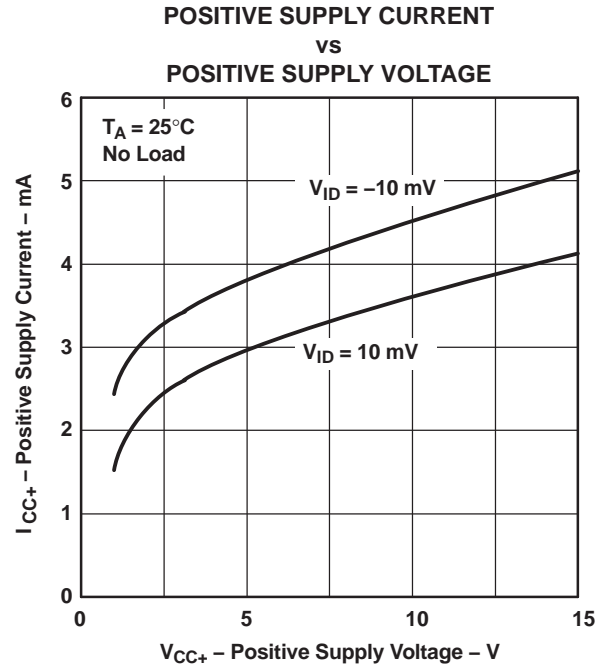


Figure 9.

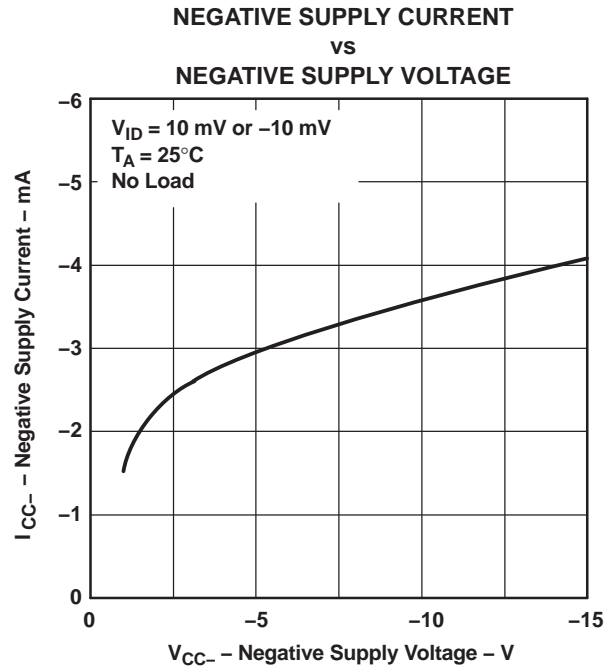
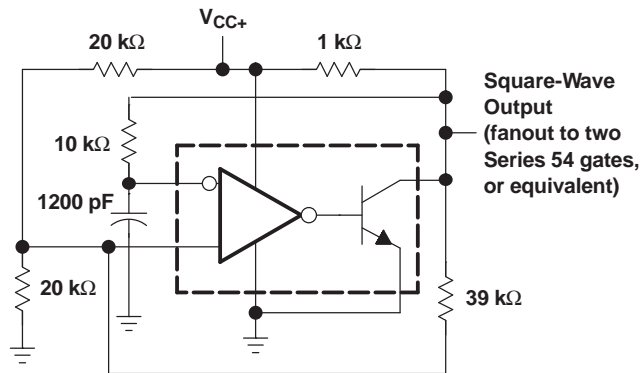


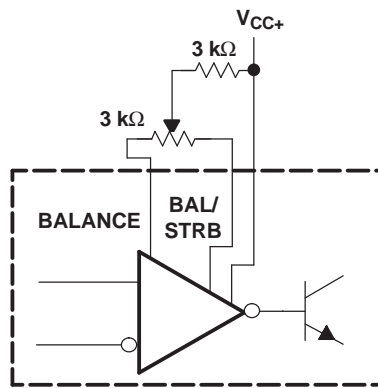
Figure 10.

**APPLICATION INFORMATION**

Figure 11 through Figure 29 show various applications for the LM211-EP comparator.

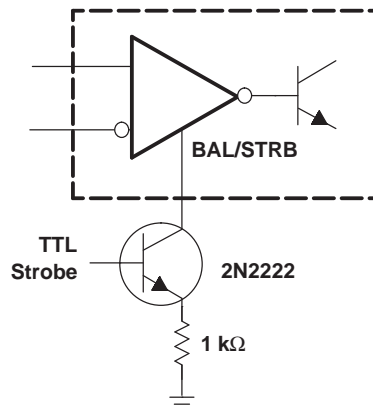


**Figure 11. 100-kHz Free-Running Multivibrator**



NOTE: If offset balancing is not used, the BALANCE and BAL/STRB pins should be shorted together.

**Figure 12. Offset Balancing**



**Figure 13. Strobbing**

APPLICATION INFORMATION (continued)

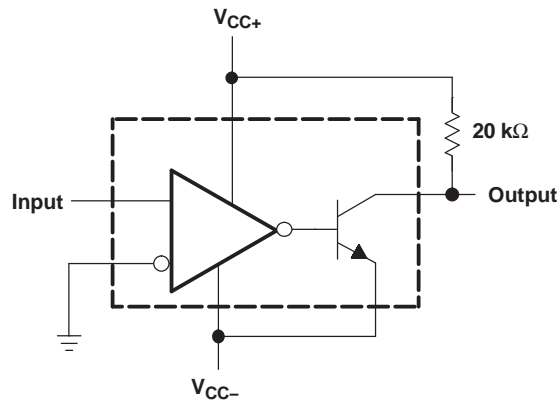
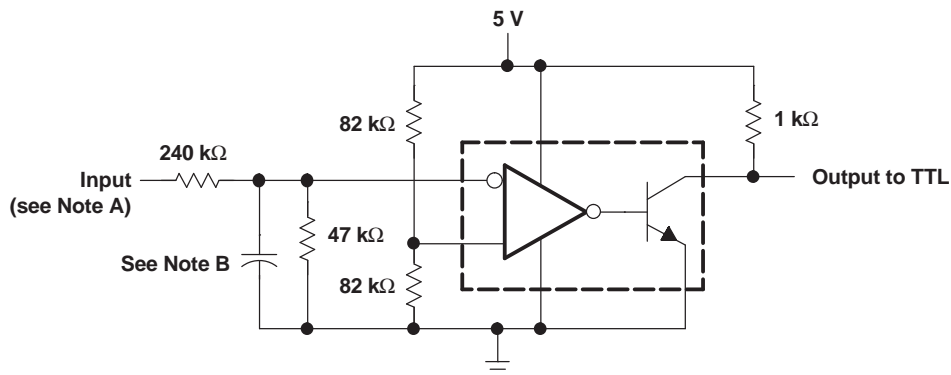


Figure 14. Zero-Crossing Detector



- A. Resistor values shown are for a 0-to-30-V logic swing and a 15-V threshold.
- B. May be added to control speed and reduce susceptibility to noise spikes

Figure 15. TTL Interface With High-Level Logic

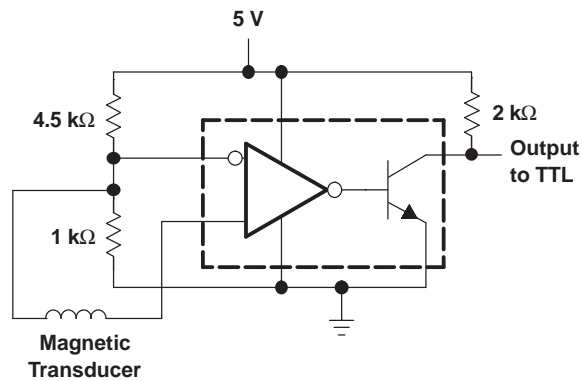


Figure 16. Detector for Magnetic Transducer

APPLICATION INFORMATION (continued)

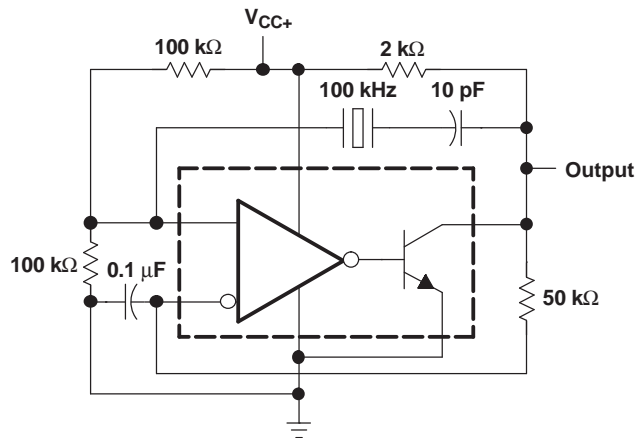


Figure 17. 100-kHz Crystal Oscillator

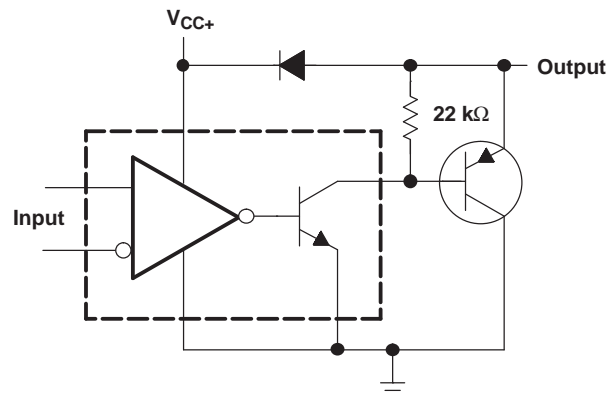
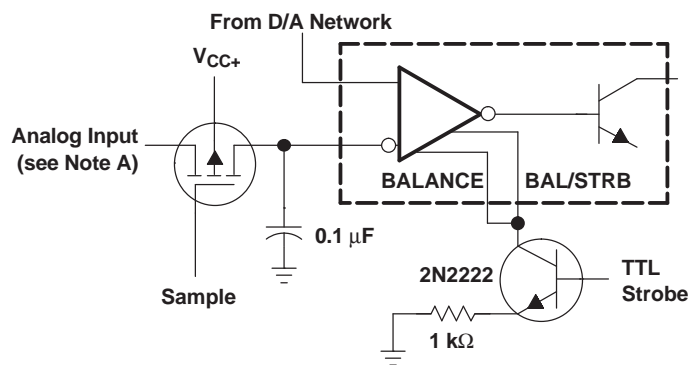


Figure 18. Comparator and Solenoid Driver



A. Typical input current is 50 pA with inputs strobed off.

Figure 19. Strobing Both Input and Output Stages Simultaneously

APPLICATION INFORMATION (continued)

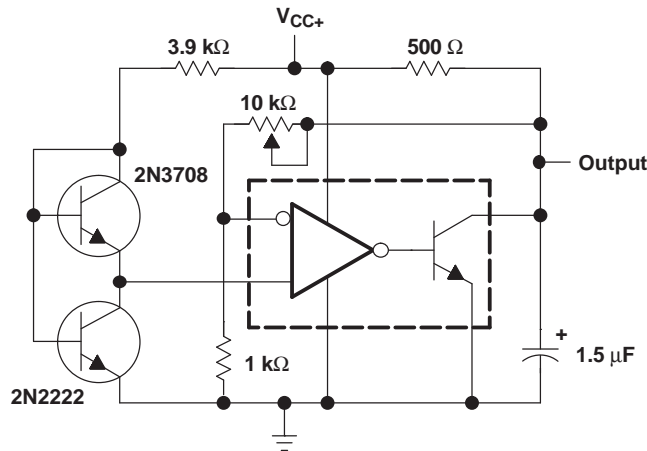


Figure 20. Low-Voltage Adjustable Reference Supply

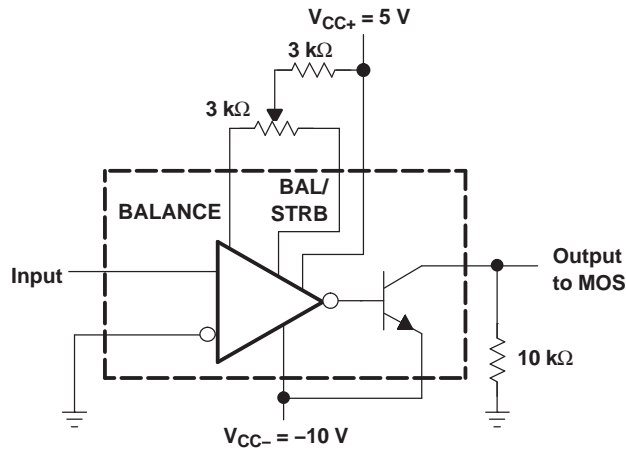
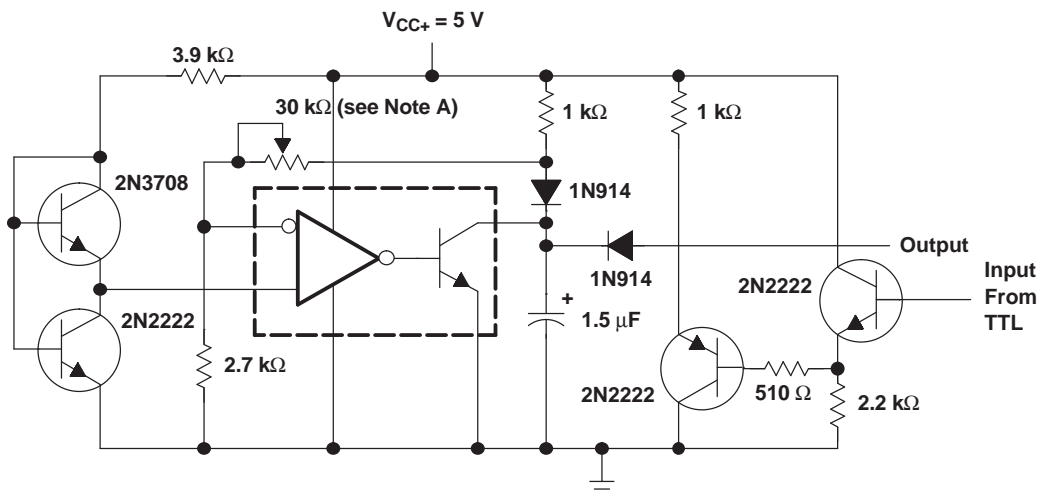


Figure 21. Zero-Crossing Detector Driving MOS Logic



A. Adjust to set clamp level

Figure 22. Precision Squarer

APPLICATION INFORMATION (continued)

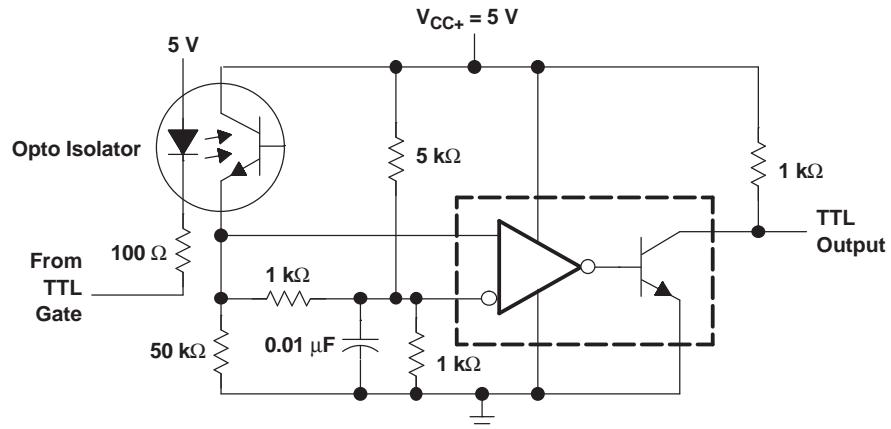


Figure 23. Digital Transmission Isolator

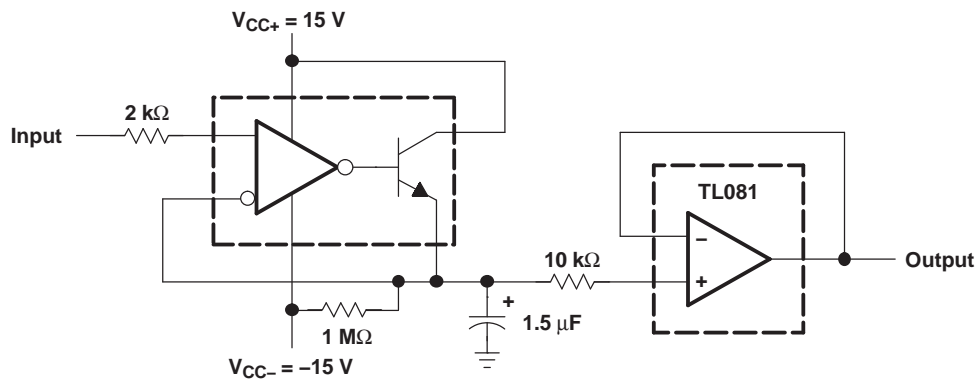


Figure 24. Positive-Peak Detector

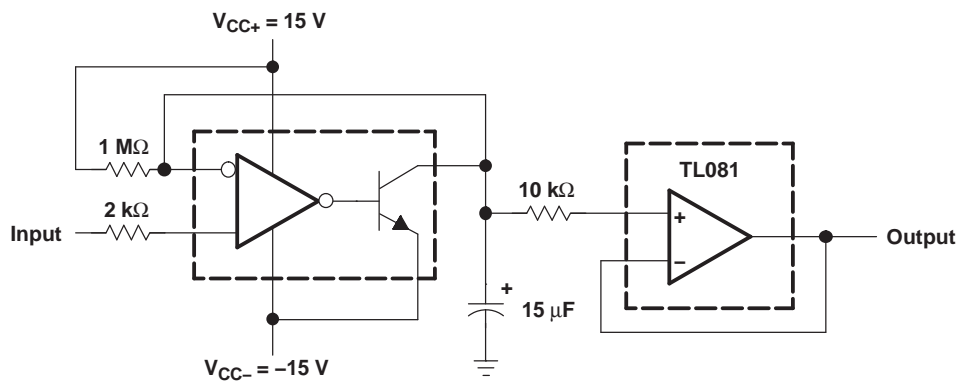
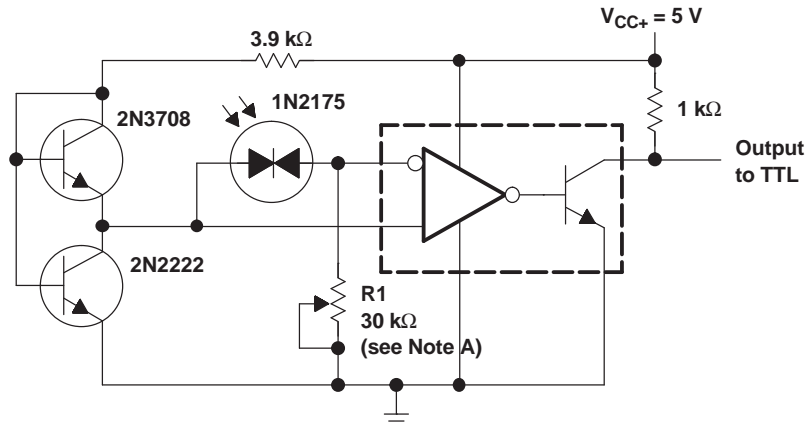


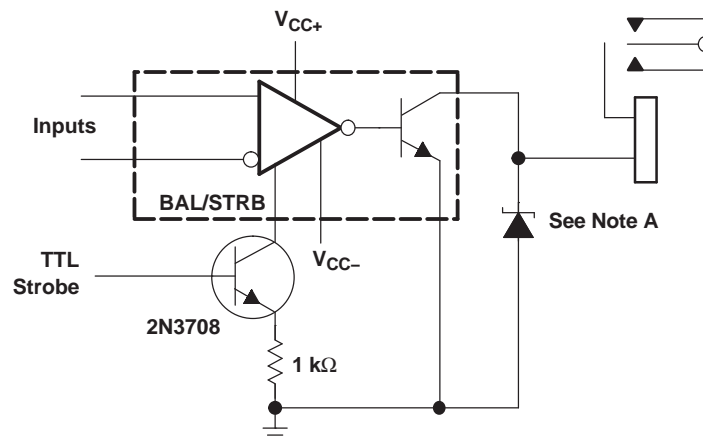
Figure 25. Negative-Peak Detector

APPLICATION INFORMATION (continued)



- A. R1 sets the comparison level. At comparison, the photodiode has less than 5 mV across it, decreasing dark current by an order of magnitude.

Figure 26. Precision Photodiode Comparator



- A. Transient voltage and inductive kickback protection

Figure 27. Relay Driver With Strobe

APPLICATION INFORMATION (continued)

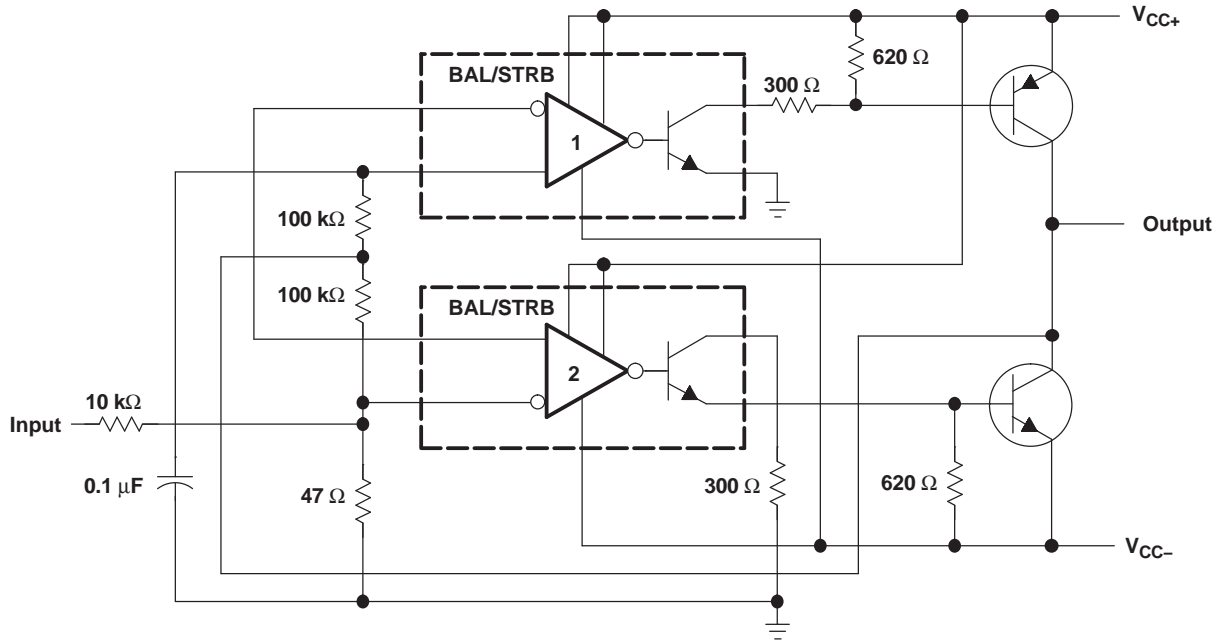


Figure 28. Switching Power Amplifier

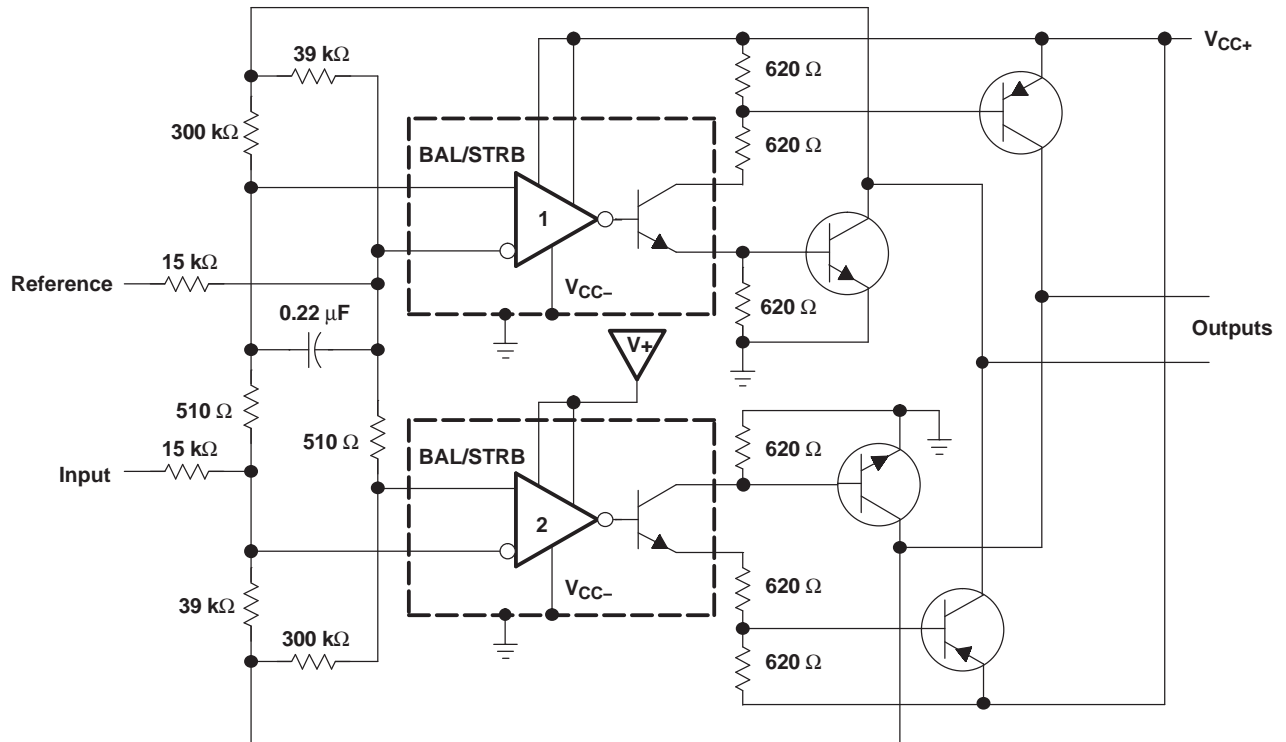


Figure 29. Switching Power Amplifiers



**PACKAGING INFORMATION**

| Orderable part number          | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|--------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">LM211MDREP</a>     | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | LM211M              |
| LM211MDREP.A                   | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | LM211M              |
| <a href="#">LM211QDREP</a>     | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LM211E              |
| LM211QDREP.A                   | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LM211E              |
| <a href="#">V62/03638-01XE</a> | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | LM211E              |
| <a href="#">V62/03638-02XE</a> | Active        | Production           | SOIC (D)   8   | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -55 to 125   | LM211M              |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF LM211-EP :**

- Catalog : [LM211](#)
- Automotive : [LM211-Q1](#)

## NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LM211MDREP | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| LM211QDREP | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LM211MDREP | SOIC         | D               | 8    | 2500 | 353.0       | 353.0      | 32.0        |
| LM211QDREP | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |



D0008A

# PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



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NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed  $.006$  [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

# EXAMPLE BOARD LAYOUT

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
 EXPOSED METAL SHOWN  
 SCALE:8X



SOLDER MASK DETAILS

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NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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